

Diodes Incorporated



# SPECIFICATION FOR APPROVAL

CUSTOMER

NOMINAL FREQUENCY

16.000000 MHz

TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL

FL1600172Q

SPEC. NO. ( P/N )

**PRODUCT TYPE** 

**CUSTOMER P/N** 

**ISSUE DATE** 

VERSION

В

July 10, 2018

APPROVED	PREPARED	QA
Brenda	Kelly	Dong Yang

### **Diodes Incorporated**

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- \*Pb-free
- \*RoHS Compliant
- \*HF-Halogen Free
- \*REACH Compliant
- \*AEC-Q200 Compliant

# TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL

## FL1600172Q

VER. B 10-Jul-18

# **VERSION HISTORY**

Version No.	Version Date	Description	Notes	
A	Aug.31,2017	Initial Release		
В	Jul.10,2018	Updated logo		



# TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL

### FL1600172Q

VER. B 10-Jul-18

### **ELECTRICAL SPECIFICATIONS**

ltem	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	16.000000	MHz	
Mode of Oscillation	MO	AT Cut-Fundamental		
Calibration Load Capacitance	CL	12	pF	
Calibration Tolerance	FL	±20	ppm	at 25℃±3℃
Operating Temperature Range	TR	-40 to +125	c	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±50	ppm	Reference to the Frequency at $25$ °C
Operating Drive Level		10	μW	
Maximum Drive Level		100	μW	
Equivalent Series Resistance	ESR	80	Ω	Max
Shunt Capacitance	C0	5	pF	Max
Aging at 25℃		±3	ppm	Max, 1st year
Storage Temperature		-55 to +125	c	
Insulation Resistance		500	MΩ	Min

💥 This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).



# **TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL**

### FL1600172Q

# Initial 1.1 Physical Dimensions: JESD22, Method JB1-100 1.2 External Visual: MIL-STD-883, Method 2009 1.3 Freq. Vs. Temperature: Per Specification/Datasheet 2. Mechanical 2.1 Mechanical Shock: MIL-STD-202 Method 213 2.2 Vibration: MIL-STD-202 Method 204 2.3 Solderability: J-STD-002

**AEC-Q200 RELIABILITY TEST SPECIFICATIONS:** 

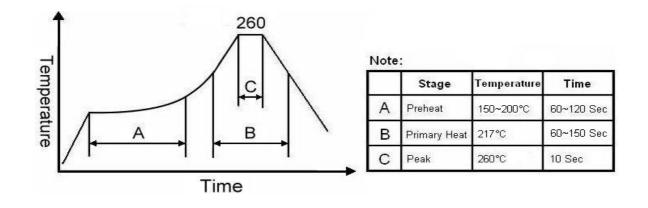
- 2.4 Board Flex: AEC Q200-005
- 2.5 Terminal Strength (SMD): AEC Q200-006

### 3.Environmental

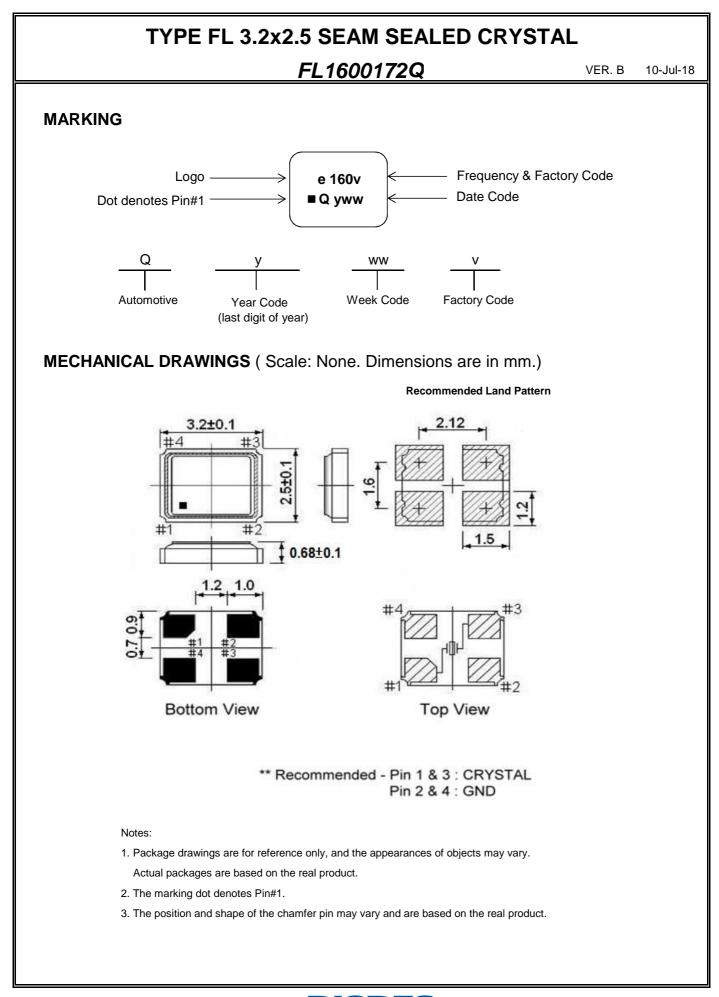
- 3.1 Temp Cycle: JESD22, Method JA-104
- 3.2 Resistance to Solder Heat: MIL-STD-202 Method 210
- 3.3 High Temperature Operating Life: MIL-STD-202, Method 108
- 3.4 High Temp Exposure: MIL-STD-202, Method 108
- 3.5 High Temp & High Humidity: MIL-STD-202, Method 103
- 3.6 Thermal Shock: MIL-STD-202, Method 107

### SUGGESTED IR REFLOW PROFILE

\*As per IPC-JEDEC J-STD-020D









# **TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL** FL1600172Q VER. B 10-Jul-18 Tape & Reel Index Mark 2.0 Ø1.0 .25±0.05 ø1.55 4.0 1.75 R0.3 $\oplus$ ŧ. 3.5±0.05 8±0.2 3.4 5 2.7 Feeding 8.0 1.4 Ø60.2±0.5 178-5 9.0±0.3 12±1.4

- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.



